## **Amendments to the Claims:**

This listing of claims will replace all prior versions, and listings, of claims in the application.

## In the Claims:

- 1. (Currently Amended) A circuit sheet, comprising:
- a substrate; and

wells disposed on the substrate and operable to hold respective conductive polymers that form circuit devices that can be interconnected to form an electronic circuit.

- 2. (Original) The sheet of claim 1, further comprising:
- a first set of ridges formed in a first direction on the substrate;
- a second set of ridges formed in a second direction on the substrate, the second direction being substantially perpendicular to the first direction; and

wherein the wells are defined by respective intersections of the first and second sets of ridges.

- 3. (Original) The sheet of claim 1 wherein the substrate is flexible.
- 4. (Currently Amended) A circuit sheet, comprising:
- a substrate; and
- a <u>chemical</u> treatment disposed on regions of the substrate and operable to limit the sizes of conductive-polymer dots printed onto the regions.
  - 5. (Currently Amended) An electronic device apparatus, comprising: a substrate;

conductive polymer dots disposed on the substrate in predetermined locations; and

a connection layer that interconnects the dots to form a circuit.

- 6. (Currently Amended) The <u>circuit electronic device apparatus</u> of claim 5, further comprising a display disposed on the connection layer and operable to be driven by the circuit.
- 7. (Currently Amended) The <u>circuit\_apparatus\_of claim 5</u> wherein at least one of the conductive polymer dots comprises polymer poly-paraphenylene vinylene poly-paraphenylene (PPP).
- 8. (Currently Amended) The <u>circuit apparatus</u> of claim 5 further comprising wells formed on the substrate in the predetermined locations and holding the dots.
- 9. (Currently Amended) The <u>circuit apparatus</u> of claim 5 wherein the predetermined locations of the substrate are <u>chemically</u> treated to limit the size of the dots.
  - 10. (Currently Amended) A circuit sheet, comprising:
  - a one and only one substrate; and

circuit components transistors disposed on the substrate and formed from a conductive polymer, wherein the transistors are isolated from one another and are operable to be interconnected to form an electronic circuit.

- 11. Cancelled.
- 12. (Currently Amended) A circuit, comprising:
- a one and only one substrate;

circuit components transistors disposed on the substrate and formed from a conductive polymer; and

conductive traces disposed on the substrate and interconnecting the <del>circuit</del> components transistors in a predetermined topology to form an electronic circuit.

- 13. (Currently Amended) The circuit of claim 12, further comprising a display disposed on the substrate and operable to be driven by the interconnected circuit components transistors.
  - 14. 21. Cancelled.
- 22. (New) The circuit sheet of claim 1, wherein the circuit devices comprise transistors.
- 23. (New) The circuit sheet of claim 4, wherein the chemical treatment smoothens a surface of the substrate.
- 24. (New) The circuit sheet of claim 4, wherein the chemical treatment comprises a wax.
- 25. (New) The apparatus of claim 5, further comprising groups of conductive polymer dots disposed on the substrate in predetermined locations, each group comprising a respective transistor.
- 26. (New) The apparatus of claim 5, wherein the wells also hold nonconductive polymer dots.
- 27. (New) The circuit of claim 12, wherein the conductive traces are formed from a conductive polymer.